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Parts & Repair Operations Louisville, KY			LOU-GEF-SYS0x				
Test Procedure for SYS01 and SYS02 Printed Circuit Boards							
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# Functional test procedure for SYS01 and SYS02 Printed Circuit Boards

## 1. SCOPE

1.1 This is a functional test procedure for testing the SYS01 and SYS02printed circuit boards. The process applies only to these boards model number 44A719346-101 and 44A719346-102.

# 2. STANDARDS OF QUALITY

**2.1** Refer to the current revision of the IPC-A-610 standard for workmanship standards.

## 3. APPLICABLE DOCUMENTS

**3.1** The following document(s) shall form part of this specification to the extent specified herein. Unless otherwise indicated, the latest issue shall apply.

3.1.1	44C719648	Elementary
3.1.2	44C719661	Elementary
3.1.3	GEK-25382	Maintenance & Troubleshooting
3.1.4	GEK-25381	Startup & Adjustments
3.1.5	GEK-25391	System Diagrams
3.1.6	GIT-200	TAB12 Diagnostic Software
3.1.7	GEK-84876	Color Graphic System

## 4. ENGINEERING REQUIREMENTS

#### 4.1 Description

4.1.1 SYS01/02 board used in the Graphics Numerical Control Station (GNCS). The System Board (SYS) provides the following major functions Processing Capability, Firmware and Diagnostic Storage, Temporary Memory Storage, Master for the GNCS Bus, Keyboard Interface, RS422 Interface with IOC, Extended Diagnostics, Support the VID01 Board, Support Interactive Part Programming, and Support Communications for BPI01.

#### 4.2 Equipment Cleaning

**4.2.1** Equipment should be clean and free of debris prior to applying power unless performing an initial check. Refer to the local documented procedures for cleaning guidelines.

# 4.3 Equipment Inspection

- **4.3.1** Equipment should be visually inspected for any defects prior to applying power. This inspection should include the following as a minimum:
  - 4.3.1.1 Wires broken or cracked
  - 4.3.1.2 Terminal strips / connectors broken or cracked
  - **4.3.1.3** Loose wires
  - 4.3.1.4 Components visually damaged
  - 4.3.1.5 Capacitors leaking
  - 4.3.1.6 Solder joints damaged or cold
  - 4.3.1.7 Circuit board burned or de-laminated
  - 4.3.1.8 Printed wire runs burned or damaged

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# 5. EQUIPMENT REQUIRED

**5.1** The following equipment is required to perform the process requirements. Equipment may be substituted provided that all accuracy's and test ratios are equivalent or better.

Qty	Reference #	Description
1	GE MC2000 GNCS Control	MC2000 Graphic/ Color Control
1	Factory Service Diagnostics	Resides on Bubble Board MB1:
1	7.59MC Software	Resides on Bubble Board MB3:
1	MC2000 PWM Drive Control	2000 Control with Axis Cart or motors

# 6. TESTING PROCESS

- **6.1** Diagnostic Test
  - **6.1.1** Install board to be tested in MC2000 CNCS Control.
  - **6.1.2** Turn on MC2000 Power Switch.
  - **6.1.3** Turn control on by depressing green "Control On" push button on the NCS Station. If the LED on the NCB does not come on, stop the testing and begin your troubleshooting.
  - **6.1.4** "Power Up Diagnostics" should be displayed on screen, followed by "System Loading", which will be followed by "Mark Century 2000 Service Diagnostics Initialization" & "Make any Keyboard entry for manual/menu mode".
  - **6.1.5** Press any key and Factory Diagnostic Screen will be displayed.
  - **6.1.6** To select a heading on the menu page, use the cursor control up or down arrow key.
  - 6.1.7 Go to manual testing of the SYS selecting "Graphic Control Station Test" and pressing enter or return. You need to go through the following Test "GCS Extended Diagnostic Test". This Test will test Keyboard Functions and Color Graphics.
  - **6.1.8** After Test Shut down Control and go on to MB3: Test.
- 6.2 MB03 7.59MC Test.
  - **6.2.1** Before turning on control be sure proper boards have been inserted into the logic rack and CPU switch is in the middle position.
  - **6.2.2** If everything is ready turn on control, pressing "ON".
  - 6.2.3 It will take a minute or so for control to boot up. Once done the CRT should display a banner page for 7.59MC control. All LEDs should be lit on all board.

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# 6.3 Part Program Test

- **6.3.1** Once control is up and on line with the 7.59MC application, Turn on axis cart and enable drives.
  - **6.3.1.1** Press Control On again, this will lock in drives from control.
  - **6.3.1.2** Tested MCB02 inputs Test High Jog and Low Jog; Tested Incr. Feed, Ref. Zero, GND, Zero, and Set Zero.
- **6.3.2** Run Part Program: Select "INDEX" on the white keys at the top of the keyboard. This should cause the control to display two or three part programs, select "MCLOOP Program" with the gray buttons, and then press POSN, one of the white keys. This should take you back to the position page.
  - **6.3.2.1** Press "Auto" and then "Cycle Start" and drive should begin to move and will continue until they are interrupted by pressing "Cancel or Clear" or removing power. Run Part Program Test for 6 hours.
  - **6.3.2.2** When complete power down control.

## 6.4 \*\*\*TEST COMPLET